

1. Product Features

1.1 Electrical features

- $V_{CES}=650V$
- $I_{C\ nom}=400A / I_{CRM}=800A$
- Low switching losses
- Low inductance
- Fast switching and short tail current
- High power and thermal cycling capability



Figure1 IGBT Module

1.2 Mechanical features

- High power and thermal cycling capability
- Al_2O_3 substrate with low thermal resistance
- Copper base plate

2. Typical Applications

- Switching mode power supply
- Drive inverters with brake system
- Uninterruptible power supply
- AC and DC servo drive amplifier

3. Description

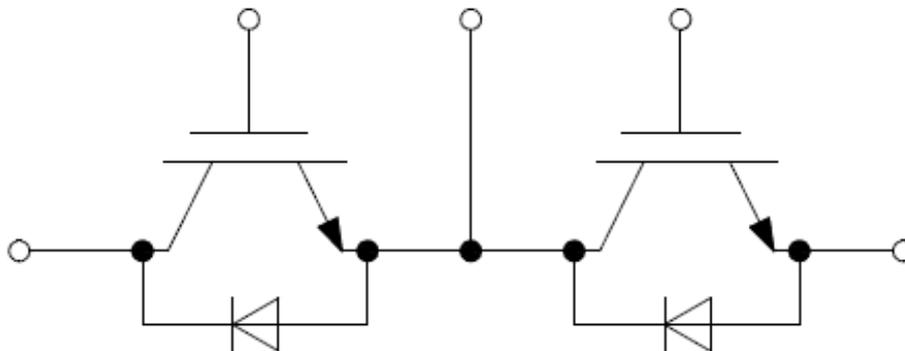


Figure 2 Half Bridge

4. IGBT, Inverter

4.1 Maximum Rated Values

Parameter	Note or test condition	Symbol	Values	Unit
Collector-emitter voltage 集电极—发射极间电压	$T_{vj} = 25^{\circ}\text{C}$	V_{CES}	650	V
Continuous DC collector current 连续集电极电流	$T_C = 100^{\circ}\text{C}, T_{vj, \max} = 150^{\circ}\text{C}$	$I_{C \text{ nom}}$	400	A
Repetitive peak collector current 集电极峰值电流	$t_P = 1 \text{ ms}$	I_{CRM}	800	A
Total power dissipation 总功率损耗	$T_C = 25^{\circ}\text{C}, T_{vj, \max} = 175^{\circ}\text{C}$	P_{tot}	1165	W
Gate-emitter peak voltage 栅极—发射极峰值电压		V_{GES}	+/- 20	V

4.2 Characteristic value

Parameter	Note or test condition	Symbol	Values			Unit	
			Min.	Typ.	Max.		
Collector-emitter saturation voltage 集电极—发射极饱和电压	$I_C = 400 \text{ A}, V_{GE} = 15 \text{ V}$	$V_{CE, \text{sat}}$		$T_{vj} = 25^{\circ}\text{C}$	1.40	1.75	V
				$T_{vj} = 125^{\circ}\text{C}$	1.50		V
				$T_{vj} = 150^{\circ}\text{C}$	1.51		V
Gate threshold voltage 栅极阈值电压	$I_C = 6.4 \text{ mA}, V_{CE} = V_{GE}, T_{vj} = 25^{\circ}\text{C}$	$V_{GE, \text{th}}$	5.0	5.8	6.5	V	
Gate charge 栅极电荷	$V_{GE} = -15 \text{ V} \dots +15 \text{ V}$	Q_G		3.0		μC	
Internal gate resistor 内部栅极电阻	$T_{vj} = 25^{\circ}\text{C}$	$R_{G \text{ int}}$		1.45		Ω	
Input capacitance 输入电容	$f = 1 \text{ MHz}, T_{vj} = 25^{\circ}\text{C}, V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}$	C_{ies}		64.7		nF	
Reverse transfer capacitance 反向传输电容	$f = 1 \text{ MHz}, T_{vj} = 25^{\circ}\text{C}, V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}$	C_{res}		0.27		nF	
Collector-emitter cut-off current 集电极-发射极截止电流	$V_{CE} = 650 \text{ V}, V_{GE} = 0 \text{ V}, T_{vj} = 25^{\circ}\text{C}$	I_{CES}			2	mA	
Gate-emitter leakage current 栅极-发射极漏电流	$V_{CE} = 0 \text{ V}, V_{GE} = 20 \text{ V}, T_{vj} = 25^{\circ}\text{C}$	I_{GES}			400	nA	
Turn-on delay time, inductive load 开通延迟时间	$I_C = 400 \text{ A}, V_{CE} = 300 \text{ V}$ $V_{GE} = +15/-15 \text{ V}$ $R_{G, \text{on}} = 3.3 \Omega$	$t_{d, \text{on}}$		$T_{vj} = 25^{\circ}\text{C}$	0.104		us
				$T_{vj} = 125^{\circ}\text{C}$	0.112		us
				$T_{vj} = 150^{\circ}\text{C}$	0.106		us
Rise time, inductive load 上升时间	$I_C = 400 \text{ A}, V_{CE} = 300 \text{ V}$ $V_{GE} = +15/-15 \text{ V}$ $R_{G, \text{on}} = 3.3 \Omega$	t_r		$T_{vj} = 25^{\circ}\text{C}$	0.068		us
				$T_{vj} = 125^{\circ}\text{C}$	0.071		us
				$T_{vj} = 150^{\circ}\text{C}$	0.073		us

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Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Turn-off delay time, inductive load 关断延迟时间	$I_C = 400A, V_{CE} = 300V$ $V_{GE} = +15/-15V$ $R_{G,off} = 3.3\Omega$	$T_{vj} = 25^\circ C$ $T_{vj} = 125^\circ C$ $T_{vj} = 150^\circ C$	$t_{d,off}$		0.222	us
					0.252	us
					0.260	us
Fall time, inductive load 下降时间	$I_C = 400A, V_{CE} = 300V$ $V_{GE} = +15/-15V$ $R_{G,off} = 3.3\Omega$	$T_{vj} = 25^\circ C$ $T_{vj} = 125^\circ C$ $T_{vj} = 150^\circ C$	t_f		0.113	us
					0.194	us
					0.222	us
Turn-on energy loss per pulse 开通损耗能量	$I_C = 400A, V_{CE} = 300V, L_s = 20nH$ $V_{GE} = +15/-15V, di/dt = 4400A/\mu s$ $R_{G,on} = 3.3\Omega (T_{vj} = 150^\circ C)$	$T_{vj} = 25^\circ C$ $T_{vj} = 125^\circ C$ $T_{vj} = 150^\circ C$	E_{on}		2.78	mJ
					3.85	mJ
					4.38	mJ
Turn-off energy loss per pulse 关断损耗能量	$I_C = 400A, V_{CE} = 300V, L_s = 20nH$ $V_{GE} = +15/-15V, dv/dt = 3700V/\mu s$ $R_{G,off} = 3.3\Omega (T_{vj} = 150^\circ C)$	$T_{vj} = 25^\circ C$ $T_{vj} = 125^\circ C$ $T_{vj} = 150^\circ C$	E_{off}		13.67	mJ
					17.54	mJ
					19.54	mJ
SC data 短路数据	$V_{GE} \leq 15V, V_{CC} = 300V, t_P \leq 8\mu s, T_{vj} = 150^\circ C,$ $C_{GE} = 0.0\mu F, V_{CEmax} = V_{CES} - L_{sCE} \cdot di/dt$		I_{sc}		2100	A
Thermal resistance, junction to case 结—外壳热阻	Per IGBT		$R_{th,jc}$			0.13 K/W

5. Diode, Inverter

5.1 Maximum Rated Values

Parameter	Note or test condition	Symbol	Values	Unit
Repetitive peak reverse voltage 反向重复峰值电压	$T_{vj} = 25^\circ C$	V_{RRM}	650	V
Continuous DC forward current 连续正向直流电流		I_F	400	A
Repetitive peak forward current 正向重复峰值电流	$t_P = 1ms$	I_{FRM}	800	A

5.2 Characteristic value

Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Forward voltage 正向电压	$I_F = 400A, V_{GE} = 0V$	V_F		1.22	V	
				1.19	V	
				1.17	V	

(table continues...) 待续

Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Peak reverse recovery current 反向恢复峰值电流	$I_F = 400A, V_R = 300V$ $V_{GE} = -15V, -di_F/dt = 3670 A/\mu s$ $(T_{vj}=150^\circ C)$	I_{RM}		300		A
				330		A
				340		A
Recovered charge 恢复电荷	$I_F = 400A, V_R = 300V$ $V_{GE} = -15V, -di_F/dt = 3670 A/\mu s$ $(T_{vj}=150^\circ C)$	Q_r		29.3		μC
				43.8		μC
				50.2		μC
Reverse recovery energy 反向恢复损耗 (每脉冲)	$I_F = 400A, V_R = 300V$ $V_{GE} = -15V, -di_F/dt = 3670 A/\mu s$ $(T_{vj}=150^\circ C)$	E_{rec}		4.2		mJ
				8.0		mJ
				9.5		mJ
Thermal resistance, junction to case 结-外壳热阻	Per diode	$R_{th,Jc}$			0.29	K/W

6. Module

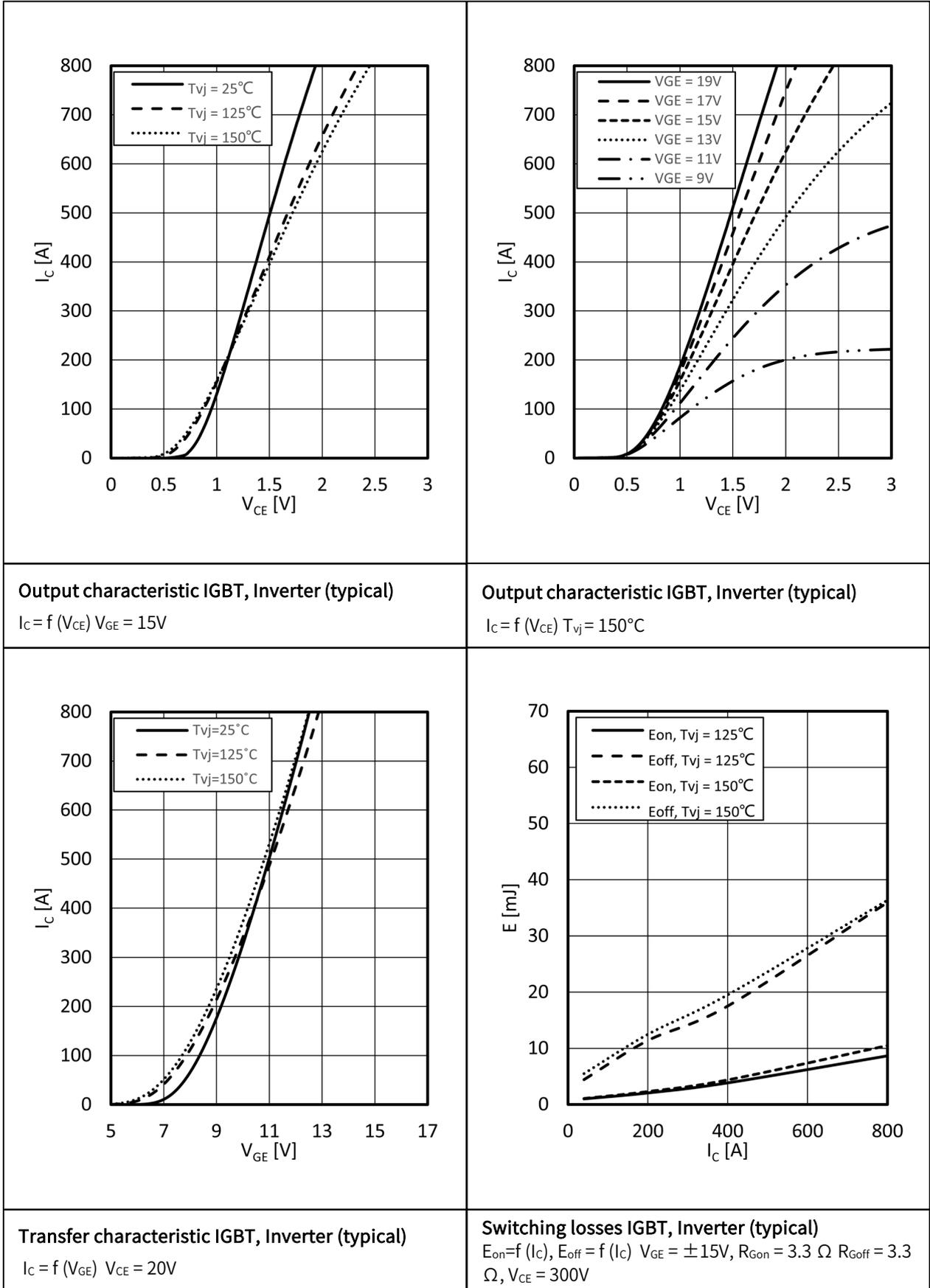
6.1 Characteristic value

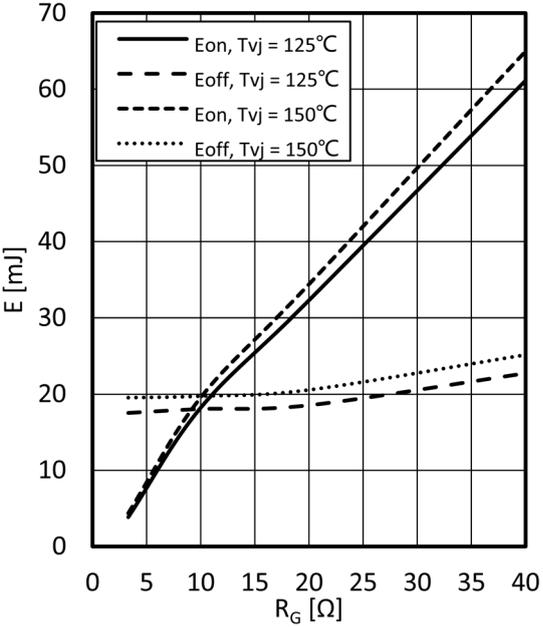
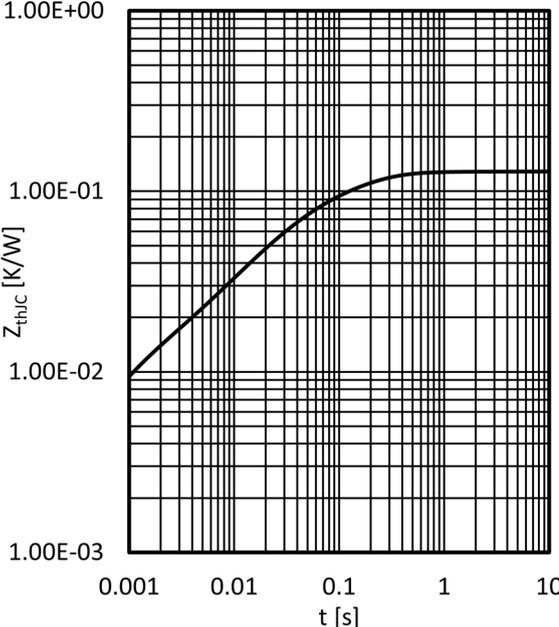
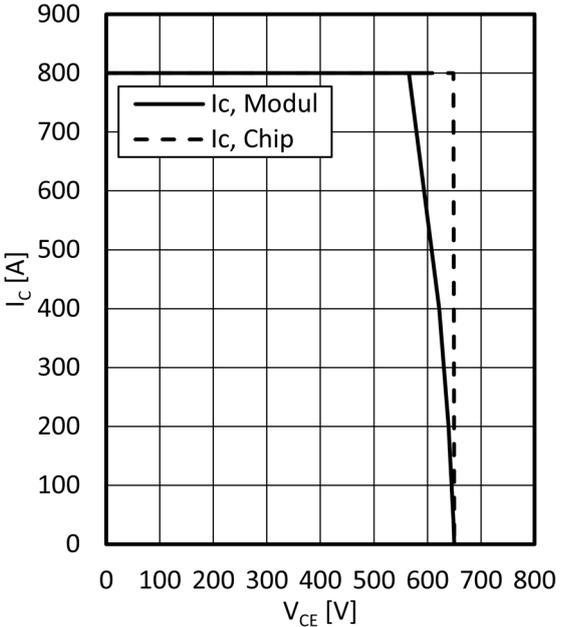
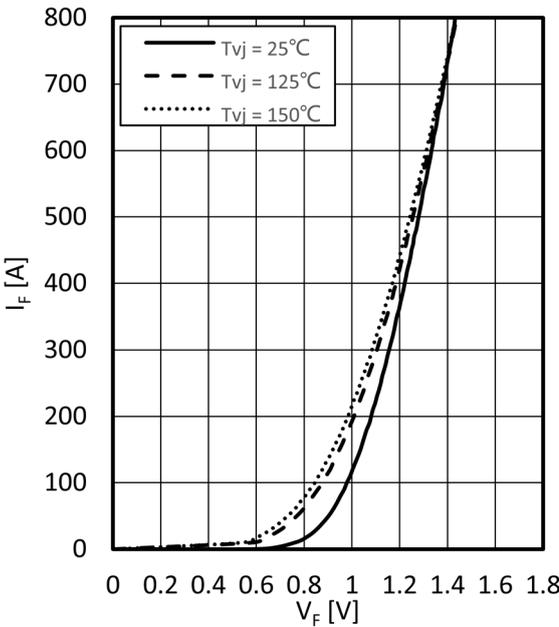
Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Isolation Voltage 隔离电压	RMS, f=50HZ,1min	V_{ISOL}			2500	V
Stray inductance module 杂散电感		L_{SCE}		20		nH

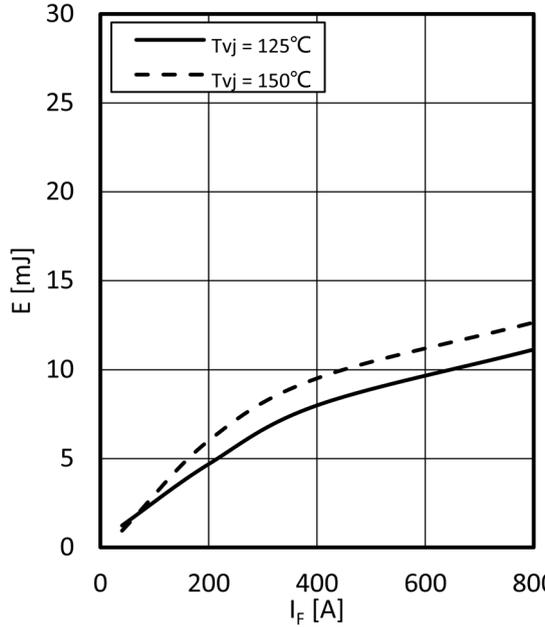
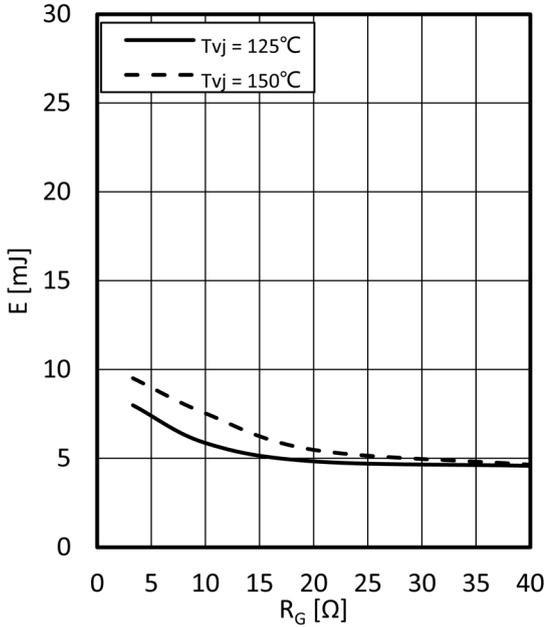
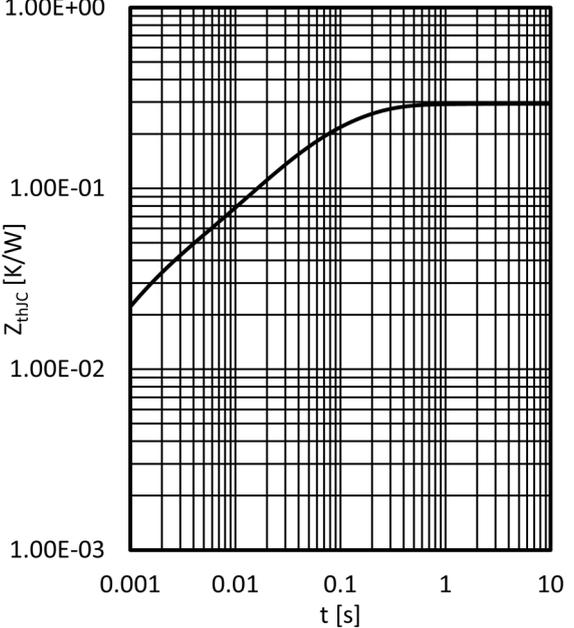
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Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Operation Junction Temperature 结温		T_{jop}	-40		150	$^\circ C$
Storage Temperature Range 存储温度范围		T_{stg}	-40		125	$^\circ C$
Mounting Torque 安装扭矩	Screw M6	M	3		6	N.m
Terminal Connection Torque 端子连接扭矩	Screw M6	M	2.5		5	N.m
Weight of Module 重量		G		340		g

7. Characteristics diagrams



	
<p>Switching losses IGBT, Inverter (typical) $E_{on} = f(R_G), E_{off} = f(R_G)$ $V_{GE} = \pm 15V, I_c = 400A, V_{CE} = 300V$</p>	<p>Transient thermal impedance IGBT, Inverter $Z_{thJC} = f(t)$</p>
	
<p>Reverse bias safe operating area IGBT, Inverter (RBSOA) $I_c = f(V_{CE})$ $V_{GE} = \pm 15V$ $R_{Goff} = 3.3 \Omega, T_{vj} = 150^\circ C$</p>	<p>Figure 10 Forward characteristic of Diode, Inverter (typical) $I_F = f(V_F)$</p>

	
<p>Switching losses Diode, Inverter (typical) $E_{rec} = f(I_F)$ $R_{Gon} = 3.3 \Omega$, $V_{CC} = 300V$</p>	<p>Switching losses Diode, Inverter (typical) $E_{rec} = f(R_G)$ $I_F = 400 A$, $V_{CC} = 300V$</p>
	
<p>Transient thermal impedance Diode Inverter $Z_{thJC} = f(t)$</p>	

8. Circuit Diagram

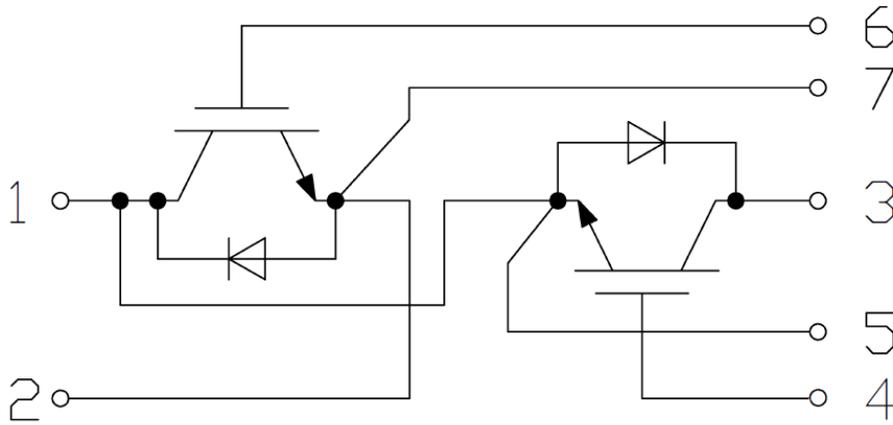


Figure 3

9. Package Outlines

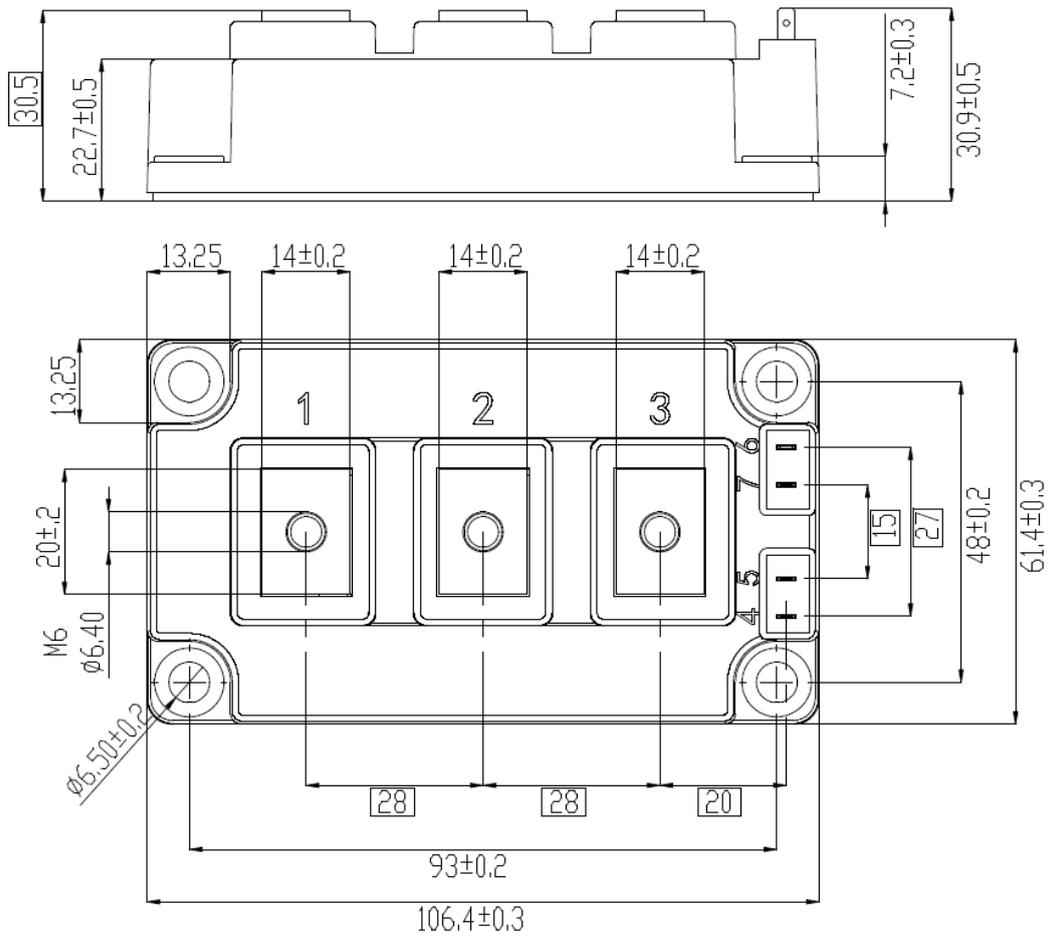


Figure 4